APPLICA	BLE STAN	DARD	PC Card Standard								
	OPERATING					STORAGE TEMPERATURE RANGE		40.00 TO :-	70 °C		
	TEMPERATURE RANGE		-55 °C TO +8	5 ·C		ERATUR ATING	KE KANGE	-40 °C TO +70			
RATING	VOLTAGE				НОМІС	DITY RA	NGE	95%MAX			
	CURRENT					(NON-CONDEN		(NON-CONDENS	NG)		
			SPECI	FICA	ADITA	JS	l				
	ГЕМ		TEST METHOD				REQUIREMENTS QT A				
CONSTRUC			TEST INCTITIES				TEQUITEMENTS Q1				
		VISUALLY AND BY MEASURING INSTRUMENT.				ACCC	RDING TO D	RAWING.	Х	X	
MARKING		CONFIRMED VISUALLY.				XX					
	AL CHARACTI	<u> </u>				NO MECHANICAL DAMAGE SHALL OCCUR   X   -					
MECHANICAL OPERATION		TIMES INSERTIONS AND EXTRACTIONS.				ON THE PARTS.				-	
[OFFICE											
ENVIRONMENT]		FREQUENCY 10 TO 2000 Hz, AMPLITUDE1.52 mm,				NO MECHANICAL DAMAGE SHALL OCCUR X — ON THE PARTS. X —					
VIBRATION AND HIGH FREQUENCY		147 m/s <sup>2</sup> PEAK FOR 4 h, IN 3 DIRECTIONS.								-	
METHOD 204D											
SHOCK		ACCELERATION 490 m/s <sup>2</sup> STANDARD HOLDING TIME 11 ms, SEMI-SINE WAVE FOR 3TIMES								-	
METHOD 213B		IN 3 DIRECTION.									
	ENTAL CHAR										
MOISTURE RESISTANCE		10 CYCLES (1 CYCLE=24 HOURS)WITH				NO HE	NO HEAVY CORROSION. X				
METHOD 106E		CONNECTORS ENGAGED.  AFTER THE TEST, THE TEST SAMPLE SHALL BE LEFT									
		AT THE AMBIENT TEMP. FOR 1 TO 2 HOURS.									
THERMAL SHOCK		TEMPERATURE -55 $\rightarrow$ +5 TO 35 $\rightarrow$ +85 $\rightarrow$ +5 TO 35 $^{\circ}$ C TIME 30 $\rightarrow$ 5 MAX. $\rightarrow$ 30 $\rightarrow$ 5 MAX. min.				NO PHYSICAL DAMAGE SHALL OCCUR X DURING TESTING.				-	
METHOD 107G		UNDER 5 CYCLES WITH CONNECTORS ENGAGED.				DOKII	NG ILSTING				
		AFTER THE TEST, THE TEST SAMPLE SHALL BE LEFT AT									
DURABILITY		THE AMBIENT TEMP. FOR 1 TO 2 HOURS.  EXPOSED AT 85 °C,250 HOURS WITH				NO PH	HYSICAL DAN	MAGE SHALL OCCUR	X	+_	
(HIGH TEMPERATURE)		CONNECTORS ENGAGED.				DURING TESTING.					
METHOD 108A		AFTER THE TEST,THE TEST SAMPLE SHALL BE LEFT AT THE AMBIENT TEMP. FOR 1 TO 2 HOURS.									
COLD RESISTANCE		EXPOSED AT -55 °C,96 HOURS WITH CONNECTORS				NO PH	HYSICAL DAI	MAGE SHALL OCCUR	Х	<del>  -</del>	
[ HO O 0000]		ENGAGED.				DURING TESTING.					
[JIS C 0020]		AFTER THE TEST, THE TEST SAMPLE SHALL BE LEFT AT THE AMBIENT TEMP. FOR 1 TO 2 HOURS.									
HUMIDITY						NO PHYSICAL DAMAGE SHALL OCCUR X -					
(NORMAL CONDITION)		WITH CONNECTORS ENGAGED. AFTER THE TEST, THE TEST SAMPLE SHALL BE LEFT				DURING TESTING.					
METHOD 103B		AT THE AMBIENT TEMP. FOR 1 TO 2 HOURS.									
HYDROGEN SULPHIDE		EXPOSED IN 3 PPM HYDROGEN SULFIDE,				NO HEAVY CORROSION X -				<b> </b>	
[JEIDA-38]		40±2°C, APPROX.80% RH,96 HOURS,									
[JEIDA-30]			WITH CONNECTORS ENGAGED. AFTER THE TEST, THE TEST SAMPLE SHALL BE LEFT								
		AT THE AMBIENT TEMP. FOR 1 TO 2 HOURS.									
CORROSION SALT MIST			EXPOSED IN 5±1 % SALT WATER SPRAY,				NO HEAVY CORROSION X -				
METH	OD 101D	35±2°C,48 HOURS, WITH CONNECTORS ENGAGED.     AFTER THE TEST,THE TEST SAMPLE SHALL BE									
			WITH WATER AND DRIED	AT THE	AMBIENT	-					
COUN	ıt 5		OR 24 HOURS.		DESIGN	IED.		CHECKED		<u> </u>	
A COUN	11 D	LOURIPH	SCRIPTION OF REVISIONS DESIG		חבטוטו/	NED CHECKED			υ <i>Ρ</i>	DATE	
REMARK		I			APPROVED KI. AKIYAMA			08 1	0. 21		
						F	CHECKED				
						Ī	DESIGNED NH. SUGITA		08. 10. 21		
Unless oth	herwise spe	cified, re	cified, refer to MIL-STD-202F.				DRAWN NH. TAMAI		08. 10. 17		
Note QT:Q	ualification Tes	t AT:Ass				AWING NO. ELC4		ELC4-153298	298-01		
HS.	S	SPECIFICATION SHEET			PART I	PART NO.		IC14-G-PEJL (10)			
1117	HIR	OSE E	LECTRIC CO., LTD.		CODE	NO	CL640-1410-6-10 🛕 1/			1/1	